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| FORM PTO-1449 | Atty. Docket No.: F12.12-0127 | Appl. No.: 10/717,800 |
| LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT | First Named Inventor: | |
| | Gary M. Klinefelter | |
| | Filing Date | Group Art: |
| | November 20, 2003 | 2854 |

U.S. PATENT DOCUMENTS

| Examiner Initial | Document No. | Date | Name | Class | Sub Class | Filing Date If Appropriate |
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| <i>DL</i> | AA | 6,001,771 | 12/14/99 | Nakano et al. | 503 | 227 |
| <i>DL</i> | AB | 6,096,396 | 8/1/00 | Patton et al. | 428 | 40.1 |
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| | AI | | | | | |

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|-----------|--------------|--------------|---------|-------|-----------|--------------------|
| <i>DL</i> | AJ | JP 11034545A | 2/1999 | Japan | | x |
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| | AL | | | | | |

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

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| <i>DL</i> | AM | Machine Translation of JP 11034545 to Shindou et al. from Japanese Patent Office Website |
| <i>DL</i> | AN | Office Communication for Application Number 10/865,521 filed June 10, 2004; date of mailing: February 22, 2005 |
| | AO | |

EXAMINER: *Don White* DATE CONSIDERED: *8/23/05*

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.